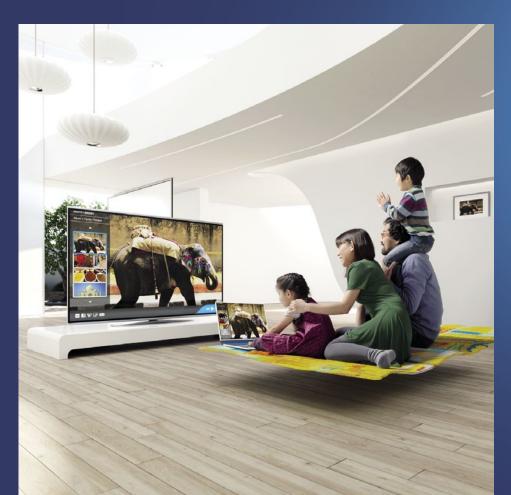


THINK YOU KNOW WHAT SMALL CAN DO? THINK AGAIN.

It's one thing to power your digital display and transfer video blazingly fast. It's another to do all that and more with a miniscule, intelligent powerhouse of a computing device. Which is why we invented the Intel® Next Unit of Computing (NUC). At a diminutive 4"×4"×2" form factor and equipped with the Third Generation Intel® Core™ i3 processor, the DC3217BY delivers stunning visuals and responsive performance from a pocket-sized solution. What's even more amazing, is that such a small device can offer so much power in an expandable, customizable package. Dramatically increase data transfer rates and transform device interconnectivity with Thunderbolt™ technology. Get a difference in performance you can truly see and feel.

SUPERIOR PROCESSING AND GRAPHICS

Visibly smart graphics using the 3rd generation Intel® Core™ i3-3217U processor deliver amazing performance and visually stunning graphics.



STUNNINGLY SMALL FORM FACTOR

The 4"×4"×2" form factor unlocks a world of potential design applications, from digital signage and kiosks to portable innovations.

ADVANCED TECHNOLOGY

The DC3217BY features Intel's Thunderbolt™ technology transforming device interconnectivity, dramatically increasing transfer performance with bi-directional 10Gbps speed, and offers daisy chaining to multiple devices, two SO-DIMM sockets for expandability upto 16 GB of memory, two PCle* mini-card connectors for flexible support of wireless and SSD configurations, BIOS vault technology, fast boot and Intel® Visual BIOS.

Integrated Board	• D33217CK
Dimensions	• 116.6mm×112.0mm×39.0mm (4.59"×4.41"×1.55")
Cooling	Active
Drive options	• mSATA
Color options	Maroon only
Chassis design	Aluminum and Plastic
Power Supply	• 19V, 65W DC-DC power adapter included
Additional Features	 Antenna for WIFI and Bluetooth pre-assembled for ease of deployment Front Panel USB 2.0 VESA mounting bracket included Product Guide





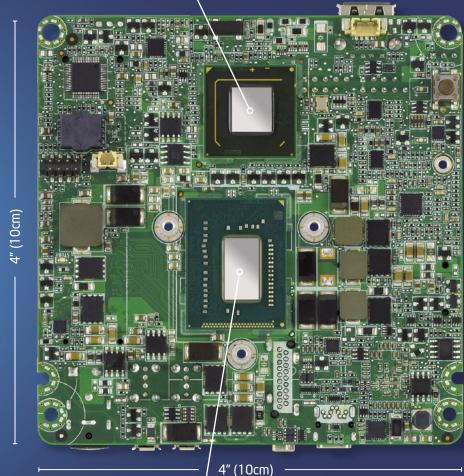


Full PC functionality in its simplest form



...with Intel® Desktop Board D33217CK

Intel® QS77 Express chipset



Intel® Core™ i3-3217U processor







Intel® Next Unit of Computing Kit DC3217BY

Technical Specifications





PROCESSOR

Processor Support

- Intel® Core™ i3 3217U Processor
 (1.8 GHz, Dual Core processor with 3 MB smart cache)
- Supports Intel® 64 architecture³

CHIPSET

Intel® QS77 Express Chipset

GRAPHICS

- Intel® HD Graphics 4000
- HDMI Port supporting HDMI 1.4a standard
- Thunderbolt port supporting display port capability

PERIPHERAL CONNECTIVITY

 Three Hi-Speed USB 2.0 ports (two back panel ports and one front panel port)

EXPANSION CAPABILITIES²

- One full length mini-PCle slot supporting mSATA capability
- One half length mini-PCle slot with dual USB 2.0 ports routed

SYSTEM BIOS

- Intel® Visual Bios
- 64 Mb Flash EEPROM with Intel® Platform Innovation Framework for EFI Plug and Play
- Advanced configuration and power interface V3.0b, SMBIOS2.5
- Intel® Express BIOS update support

Fast Boot BIOS – Optimized POST for almost instant-on access to PC from power on

SYSTEM MEMORY¹ Memory Capacity

 Dual-channel DDR3 with two connectors for 1600/1333/1066 MHz memory support (16 GB max)

Memory Voltage

• 1.5V and 1.35V

HARDWARE MANAGEMENT FEATURES

- Processor fan speed control
- Voltage and temperature sensing
- Fan sensor inputs used to monitor fan activity
- ACPI-compliant power management control

THUNDERBOLT CONNECTOR

 10 Gb/s bi-directional and dual protocol for data and display

AUDIC

 Intel® High Definition Audio (Intel HD Audio) via via one HDMI 1.4a output and/or via one ThunderBolt connector (DisplayPort 1.1a) supporting 8-channel (7.1) digital audio

INDICATORS AND CONTROLS

- HDD LED, Power LED
- Power on/off

MECHANICAL

Chassis Size

- 4.59"×4.41"×1.55" (116.6mm×112.0mm×39.0mm)

 Board Size
- 4"×4" (101.6mm×101.6mm)
 Baseboard Power Requirements
- DC Power 19V, 65 Watt

ENVIRONMENT

Operating Temperature

- 0°C to +55°C
- Storage Temperature
- -20°C to +70°C

COMPLIANCE WITH REGULATIONS AND STANDARDS

Safety Regulations

UL/CSA 60950-1 EN 60950-1

IEC 60950-1

NOM-019-SCFI-1998

GOST-R

EMC Class B Regulations

CISPR 22 CIPSR 24

FCC 47 CFR Part 15, Subpart B

ICES-003 EN 55022 EN 55024

EN 61000-3-2 EN 61000-3-3

IEC/EN 61000-4 Series

VCCI V-3 KN-22 KN-24

CNS 13438

ENVIRONMENTAL COMPLIANCE

Europe RoHS China RoHS

1 WARNING: Altering PC memory frequency, voltage and/or latency may: (i) reduce system stability and useful life of the system, memory and processor; (ii) cause the processor and other system components to fail; (iii) cause reductions in system performance; (iv) cause additional heat or other damage; and (v) affect system data integrity. Intel has not tested, and does not warranty, the operation of the memory beyond its specifications. Intel assumes no responsibility that the memory, including if used with altered clock frequencies and/or voltages, will be fit for any particular purpose. Check with memory manufacture for warranty and additional details.

2 System resources and hardware (such as PCI and PCI Express*) require physical memory address locations that can reduce available addressable system memory. This could result in a reduction of as much as 1 GB or more of physical addressable memory being available to the operating system and applications, depending on the system conflouration and operating system.

3 64-bit computing on Intel® architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See http://developer. intel.com/technology/ intel64/index.htm for more information. INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTELE PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTELS TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER, AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT, OR OTHER INTELLECTUAL PROPERTY RIGHT.

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Actual Intel® Desktop Board may differ from the image shown.

Requires an Intel® WiDi enabled system and Intel WiDi enabled receiver device. or 3rd gen Intel® Core® processor-based PCs with built-in visuals enabled, a compatible receiver device and media player, and supporting Intel WiDi software and graphics driver installed. Consult your PC manufacturer. For more information, see www.intel.com/go/widi.

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